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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

TI-30105

Jay B. Reimer, et al.

Art Unit: 2111

Serial No.:

10/008,696

Examiner: Khanh Dang

Filed:

October 30, 2001

Conf. No.: 7469

For:

Multicore DSP Device Having Coupled Subsystem Memory Buses for Global DMA

Access

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Jay B. Reimer, et al.		Serial No.: 10/008,696
Multicore DSP Device Having Coupled Subsystem		Filing Date: October 30, 2001
Memory Buses for Global DMA Access		
TI FILE NO.:	DEPOSIT ACCT. NO.:	
TI-30105	20-0668	
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